## **BCX56-10R1**

**Preferred Device** 

# NPN Silicon Epitaxial Transistor

These NPN Silicon Epitaxial transistors are designed for use in audio amplifier applications. The device is housed in the SOT-89 package, which is designed for medium power surface mount applications.

• High Current: 1.0 Amp

• Available in 7 inch/1000 unit Tape and Reel

• Device Marking: BK

## **MAXIMUM RATINGS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	VCEO	80	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	100	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	5	Vdc
Collector Current	IC	1	Adc
Total Power Dissipation  @ T <sub>A</sub> = 25°C  Derate above 25°C	P <sub>D</sub> (Note 1.) (Note 2.)	1.56 13 0.67 5.0	Watts mW/°C Watts mW/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to 150	°C

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction-to-Ambient (surface mounted)	R <sub>θ</sub> JA (Note 1.) (Note 2.)	80 190	°C/W
Maximum Temperature for Soldering Purposes Time in Solder Bath	TL	260 10	°C Sec

1. FR-4 @ 1.0 X 1.0 inch Pad

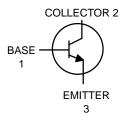
2. FR-4 @ Minimum Pad



## ON Semiconductor™

http://onsemi.com

MEDIUM POWER
NPN SILICON
HIGH CURRENT
TRANSISTOR
SURFACE MOUNT





SOT-89 CASE 1213 STYLE 2



**MARKING DIAGRAM** 

Y = Year CodeM = Month CodeBK = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping		
BCX56-10R1	SOT-89	1000/Tape & Reel		

**Preferred** devices are recommended choices for future use and best overall value.

## BCX56-10R1

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristics	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•		•
Collector-Base Breakdown Voltage (I <sub>C</sub> = 100 μAdc, I <sub>E</sub> = 0)	V(BR)CBO	100	_	_	Vdc
Collector-Emitter Breakdown Voltage (I <sub>C</sub> = 1.0 mAdc, I <sub>B</sub> = 0)	V(BR)CEO	80	_	-	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10 \mu Adc, I_C = 0$ )	V(BR)EBO	5.0	_	-	Vdc
Collector-Base Cutoff Current (V <sub>CB</sub> = 30 Vdc, I <sub>E</sub> = 0)	ICBO	_	_	100	nAdc
Emitter-Base Cutoff Current (V <sub>EB</sub> = 5.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	_	_	10	μAdc
ON CHARACTERISTICS (Note 3.)					
DC Current Gain (I <sub>C</sub> = 5.0 mA, V <sub>CE</sub> = 2.0 V) (I <sub>C</sub> = 150 mA, V <sub>CE</sub> = 2.0 V) (I <sub>C</sub> = 500 mA, V <sub>CE</sub> = 2.0 V)	hFE	25 63 25	- - -	_ 160 _	-
Collector-Emitter Saturation Voltage (I <sub>C</sub> = 500 mAdc, I <sub>B</sub> = 50 mAdc)	VCE(sat)	-	_	0.5	Vdc
Base-Emitter On Voltage (I <sub>C</sub> = 500 mAdc, V <sub>CE</sub> = 2.0 Vdc)	V <sub>BE</sub> (on)	-	-	1.0	Vdc
DYNAMIC CHARACTERISTICS					
Current-Gain – Bandwidth Product (I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 5.0 Vdc, f = 35 MHz)	fT	_	130	-	MHz

<sup>3.</sup> Pulse Test: Pulse Width  $\leq 300~\mu s,~Duty~Cycle \leq 2.0\%$ 

## TYPICAL ELECTRICAL CHARACTERISTICS

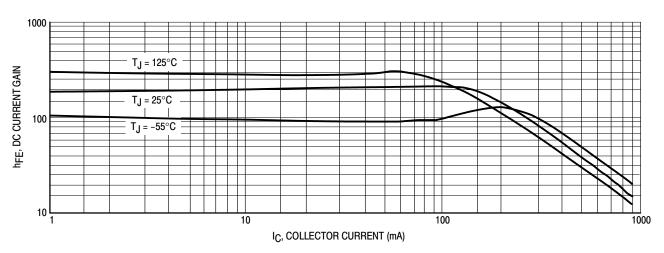
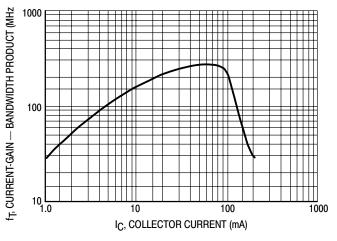


Figure 1. DC Current Gain

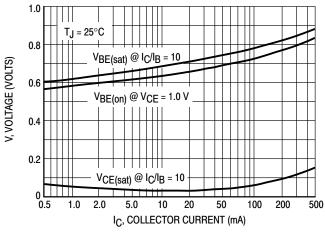
#### TYPICAL ELECTRICAL CHARACTERISTICS



80 60 40 40 Cibo T<sub>J</sub> = 25°C Cibo 8.0 6.0 4.0 0.1 0.2 0.5 1.0 2.0 5.0 10 20 50 100 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 2. Current-Gain - Bandwidth Product

Figure 3. Capacitance



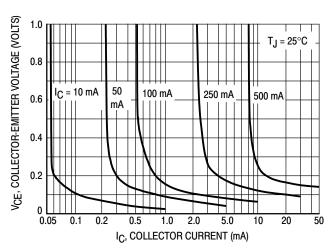


Figure 4. "On" Voltages

Figure 5. Collector Saturation Region

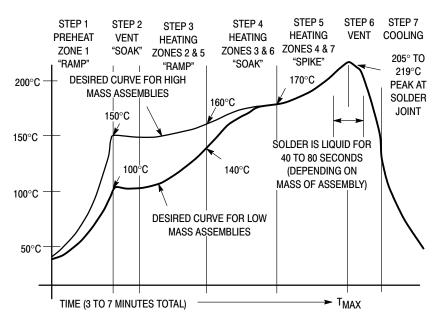
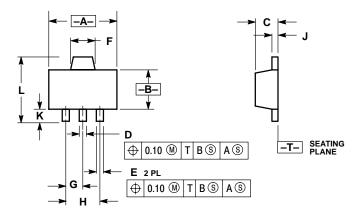


Figure 6. Typical Solder Heating Profile

#### BCX56-10R1

#### **PACKAGE DIMENSIONS**

**SOT-89** (3-LEAD) CASE 1213-02 ISSUE C



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   Y14 5M 1982
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. 1213-01 OBSOLETE, NEW STANDARD 1213-02.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.40	4.60	0.173	0.181
В	2.40	2.60	0.094	0.102
С	1.40	1.60	0.055	0.063
D	0.37	0.57	0.015	0.022
Е	0.32	0.52	0.013	0.020
F	1.50	1.83	0.059	0.072
G	1.50 BSC		0.059 BSC	
Н	3.00 BSC		0.118 BSC	
J	0.30	0.50	0.012	0.020
K	0.80		0.031	
Г		4.25		0.167

STYLE 2: PIN 1. BASE 2. COLLECTOR 3. EMITTER

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